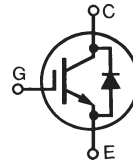


GenX3™ 600V IGBT with Diode

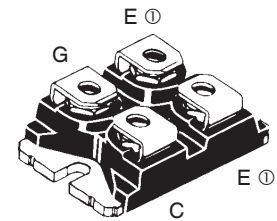
IXGN72N60C3H1

High-Speed Low-V_{sat} PT
IGBTs 40-100 kHz Switching



| | | |
|---------------|---|--------------|
| V_{CES} | = | 600V |
| I_{C110} | = | 52A |
| $V_{CE(sat)}$ | ≤ | 2.50V |
| $t_{fi(typ)}$ | = | 55ns |

SOT-227B, miniBLOC
 E153432



G = Gate, C = Collector, E = Emitter
 ① either emitter terminal can be used as
 Main or Kelvin Emitter

| Symbol | Test Conditions | Maximum Ratings | |
|----------------|--|-------------------------|-----------|
| V_{CES} | $T_J = 25^\circ\text{C to } 150^\circ\text{C}$ | 600 | V |
| V_{CGR} | $T_J = 25^\circ\text{C to } 150^\circ\text{C}, R_{GE} = 1\text{M}\Omega$ | 600 | V |
| V_{GES} | Continuous | ±20 | V |
| V_{GEM} | Transient | ±30 | V |
| I_{C25} | $T_C = 25^\circ\text{C}$ | 78 | A |
| I_{C110} | $T_C = 110^\circ\text{C}$ | 52 | A |
| I_{CM} | $T_C = 25^\circ\text{C}, 1\text{ms}$ | 360 | A |
| I_A | $T_C = 25^\circ\text{C}$ | 50 | A |
| E_{AS} | $T_C = 25^\circ\text{C}$ | 500 | mJ |
| SSOA | $V_{GE} = 15\text{V}, T_{VJ} = 125^\circ\text{C}, R_G = 2\Omega$ | $I_{CM} = 150$ | A |
| (RBSOA) | Clamped Inductive Load | @ $V_{CE} \leq V_{CES}$ | |
| P_C | $T_C = 25^\circ\text{C}$ | 360 | W |
| T_J | | -55 ... +150 | °C |
| T_{JM} | | 150 | °C |
| T_{stg} | | -55 ... +150 | °C |
| V_{ISOL} | 50/60Hz | $t = 1\text{min}$ | 2500 V~ |
| | $I_{ISOL} \leq 1\text{mA}$ | $t = 1\text{s}$ | 3000 V~ |
| M_d | Mounting Torque | 1.5/13 | Nm/lb.in. |
| | Terminal Connection Torque | 1.3/11.5 | Nm/lb.in. |
| Weight | | 30 | g |

Features

- Optimized for Low Switching Losses
- Square RBSOA
- Aluminium Nitride Isolation
- High Power Dissipation
- Isolation Voltage 3000V~
- Avalanche Rated
- Anti-Parallel Ultra Fast Diode
- International Standard Package

Advantages

- High Power Density
- Low Gate Drive Requirement

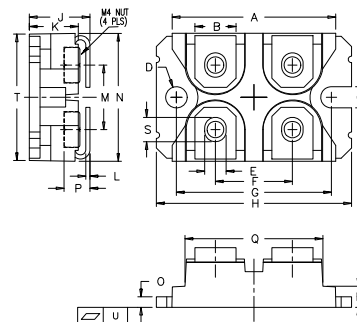
Applications

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified) | Characteristic Values | | |
|---------------|---|-----------------------|------|-------------------|
| | | Min. | Typ. | Max. |
| $V_{GE(th)}$ | $I_C = 250\mu\text{A}, V_{CE} = V_{GE}$ | 3.0 | | 5.5 V |
| I_{CES} | $V_{CE} = V_{CES}, V_{GE} = 0\text{V}$ $T_J = 125^\circ\text{C}$ | | | 250 μA |
| | | | | 3 mA |
| I_{GES} | $V_{CE} = 0\text{V}, V_{GE} = \pm 20\text{V}$ | | | ±100 nA |
| $V_{CE(sat)}$ | $I_C = 50\text{A}, V_{GE} = 15\text{V}, \text{Note 1}$ $T_J = 125^\circ\text{C}$ | | 2.10 | 2.50 V |
| | | | 1.65 | |

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified) | Characteristic Values | | |
|--------------|--|-----------------------|------|--------------------|
| | | Min. | Typ. | Max. |
| g_{fs} | $I_C = 50\text{A}$, $V_{CE} = 10\text{V}$, Note 1 | 33 | 55 | S |
| C_{ies} | $V_{CE} = 25\text{V}$, $V_{GE} = 0\text{V}$, $f = 1\text{MHz}$ | | 4780 | pF |
| C_{oes} | | | 330 | pF |
| C_{res} | | | 117 | pF |
| Q_g | $I_C = 50\text{A}$, $V_{GE} = 15\text{V}$, $V_{CE} = 0.5 \cdot V_{CES}$ | | 174 | nC |
| Q_{ge} | | | 33 | nC |
| Q_{gc} | | | 72 | nC |
| $t_{d(on)}$ | Inductive load, $T_J = 25^\circ\text{C}$ $I_C = 50\text{A}$, $V_{GE} = 15\text{V}$ $V_{CE} = 480\text{V}$, $R_G = 2\Omega$, Note 2 | | 27 | ns |
| t_{ri} | | | 37 | ns |
| E_{on} | | | 1.03 | mJ |
| $t_{d(off)}$ | | | 77 | 130 ns |
| t_{fi} | | | 55 | 110 ns |
| E_{off} | | | 0.48 | 0.95 mJ |
| $t_{d(on)}$ | Inductive load, $T_J = 125^\circ\text{C}$ $I_C = 50\text{A}$, $V_{GE} = 15\text{V}$ $V_{CE} = 480\text{V}$, $R_G = 2\Omega$, Note 2 | | 26 | ns |
| t_{ri} | | | 36 | ns |
| E_{on} | | | 1.48 | mJ |
| $t_{d(off)}$ | | | 120 | ns |
| t_{fi} | | | 124 | ns |
| E_{off} | | | 0.93 | mJ |
| R_{thJC} | | | 0.35 | $^\circ\text{C/W}$ |
| R_{thCS} | | 0.05 | | $^\circ\text{C/W}$ |

SOT-227B miniBLOC



M4 screws (4x) supplied

| SYM | INCHES | | MILLIMETERS | |
|-----|--------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 1.240 | 1.255 | 31.50 | 31.88 |
| B | .307 | .323 | 7.80 | 8.20 |
| C | .161 | .169 | 4.09 | 4.29 |
| D | .161 | .169 | 4.09 | 4.29 |
| E | .161 | .169 | 4.09 | 4.29 |
| F | .587 | .595 | 14.91 | 15.11 |
| G | 1.186 | 1.193 | 30.12 | 30.30 |
| H | 1.496 | 1.505 | 38.00 | 38.23 |
| J | .460 | .481 | 11.68 | 12.22 |
| K | .351 | .378 | 8.92 | 9.60 |
| L | .030 | .033 | 0.76 | 0.84 |
| M | .496 | .506 | 12.60 | 12.85 |
| N | .990 | 1.001 | 25.15 | 25.42 |
| O | .078 | .084 | 1.98 | 2.13 |
| P | .195 | .235 | 4.95 | 5.97 |
| Q | 1.045 | 1.059 | 26.54 | 26.90 |
| R | .155 | .174 | 3.94 | 4.42 |
| S | .186 | .191 | 4.72 | 4.85 |
| T | .968 | .987 | 24.59 | 25.07 |
| U | -.002 | .004 | -0.05 | 0.1 |

Reverse Diode (FRED)

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified) | Characteristic Values | | |
|------------|--|-----------------------|------|-------------------------|
| | | Min. | Typ. | Max. |
| V_F | $I_F = 60\text{A}$, $V_{GE} = 0\text{V}$, Note 1 $T_J = 150^\circ\text{C}$ | | 1.6 | 2.0 V |
| | | | 1.4 | 1.8 V |
| I_{RM} | $I_F = 60\text{A}$, $V_{GE} = 0\text{V}$, $-di_F/dt = 200\text{A}/\mu\text{s}$, $V_R = 300\text{V}$ $T_J = 100^\circ\text{C}$ | | 8.3 | A |
| t_{rr} | | | 140 | ns |
| R_{thJC} | | | | 0.42 $^\circ\text{C/W}$ |

Notes:

1. Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.
2. Switching times & energy losses may increase for higher $V_{CE}(\text{Clamp})$, T_J or R_G .

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

| | | | | | | | | | | |
|--|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|-------------|
| IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665 | 6,404,065 B1 | 6,683,344 | 6,727,585 | 7,005,734 B2 | 7,157,338B2 |
| | 4,850,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343 | 6,710,405 B2 | 6,759,692 | 7,063,975 B2 | |
| | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505 | 6,710,463 | 6,771,478 B2 | 7,071,537 | |

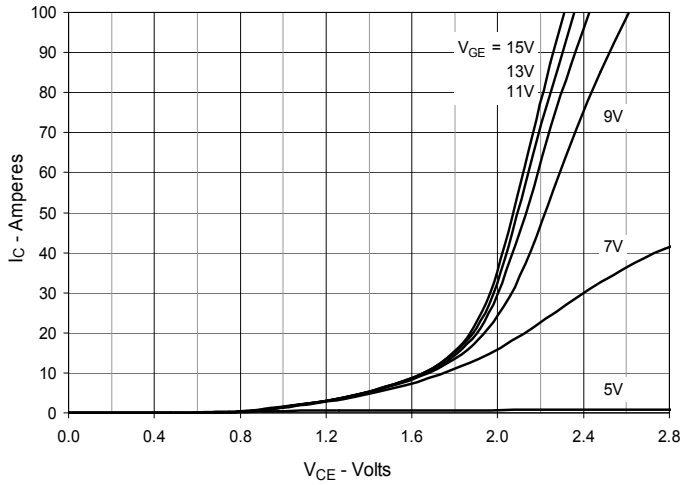
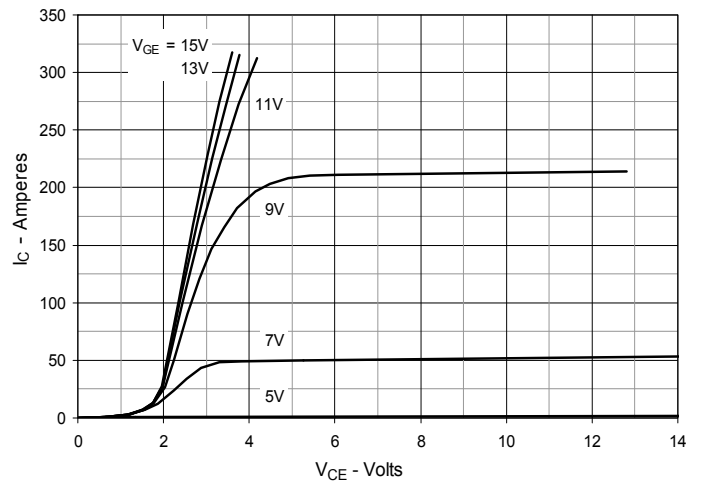
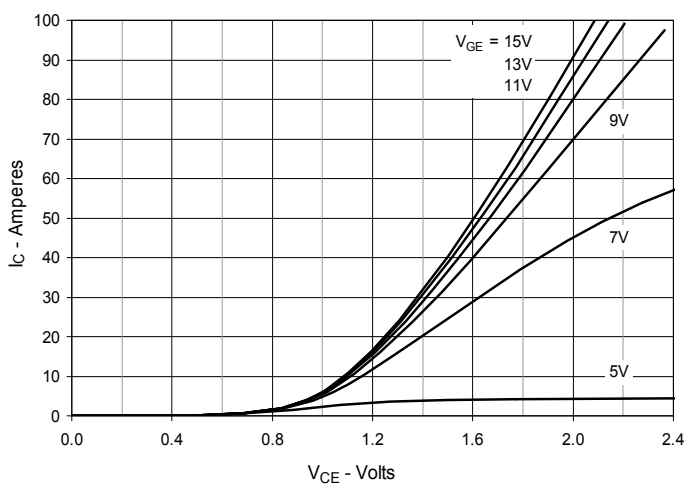
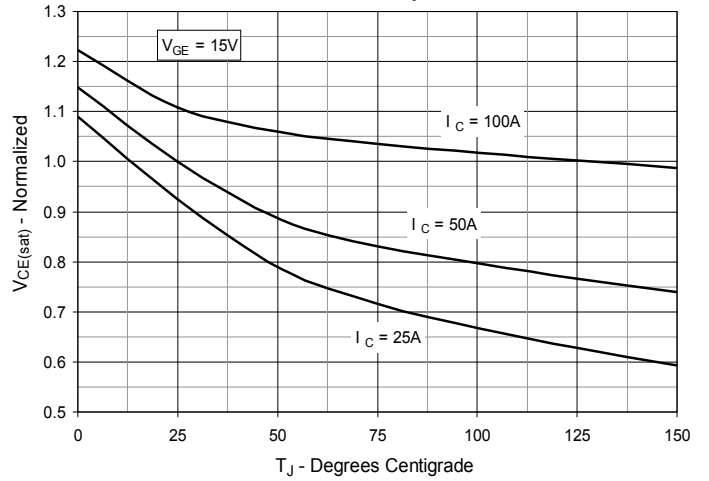
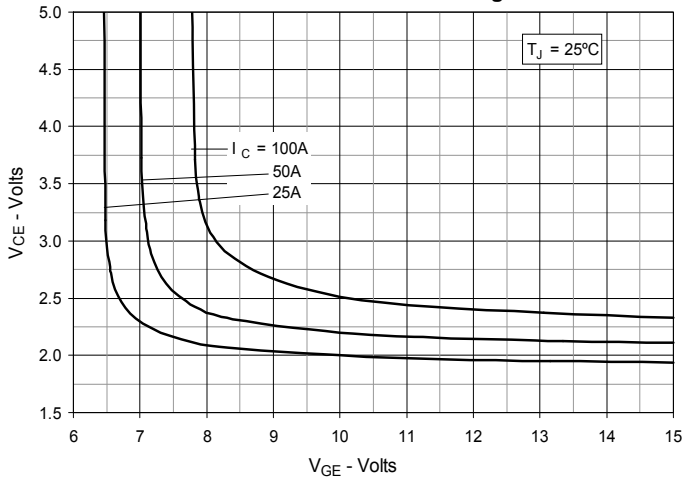
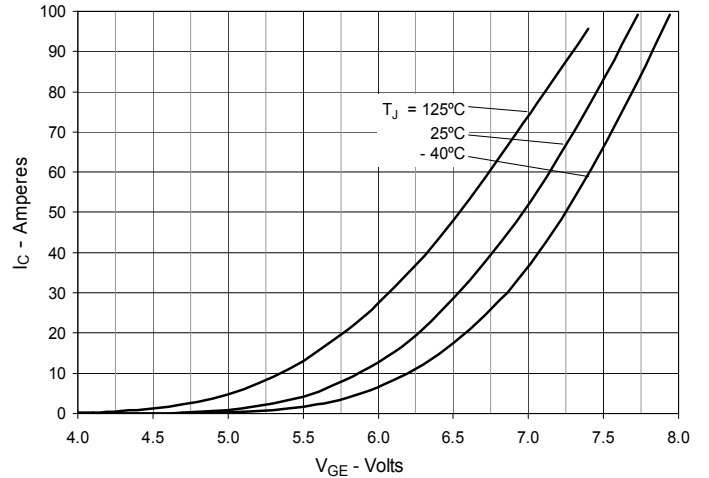
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$

Fig. 4. Dependence of $V_{CE(sat)}$ on Junction Temperature

Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

Fig. 6. Input Admittance


Fig. 7. Transconductance

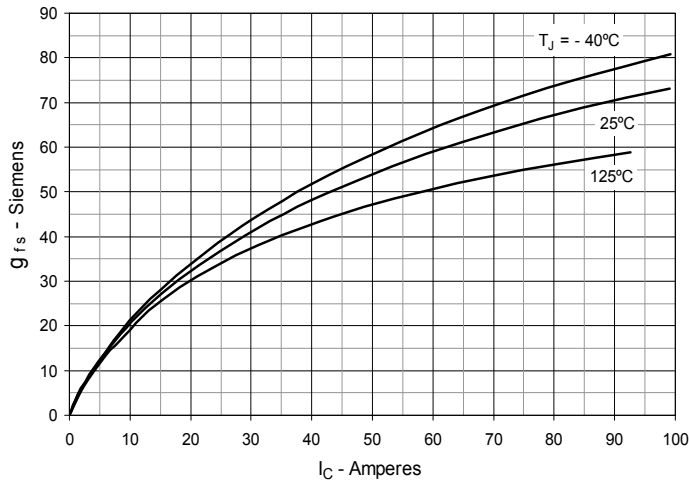


Fig. 8. Gate Charge

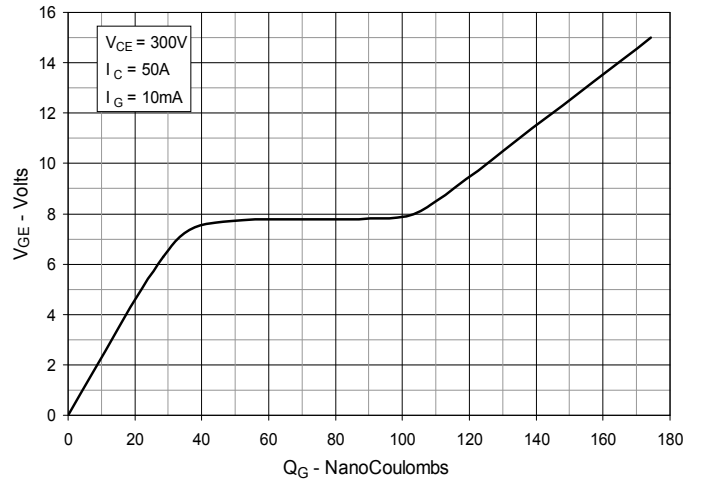


Fig. 9. Capacitance

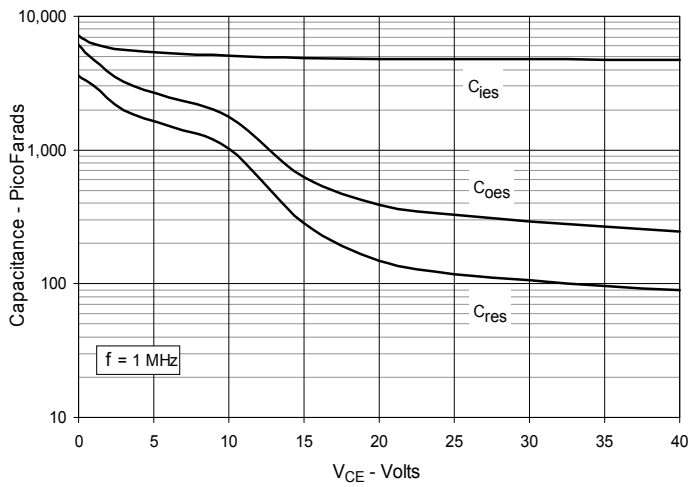


Fig. 10. Reverse-Bias Safe Operating Area

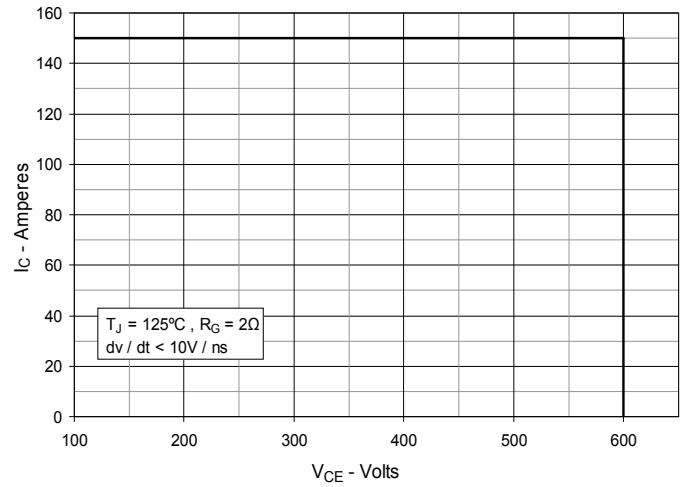
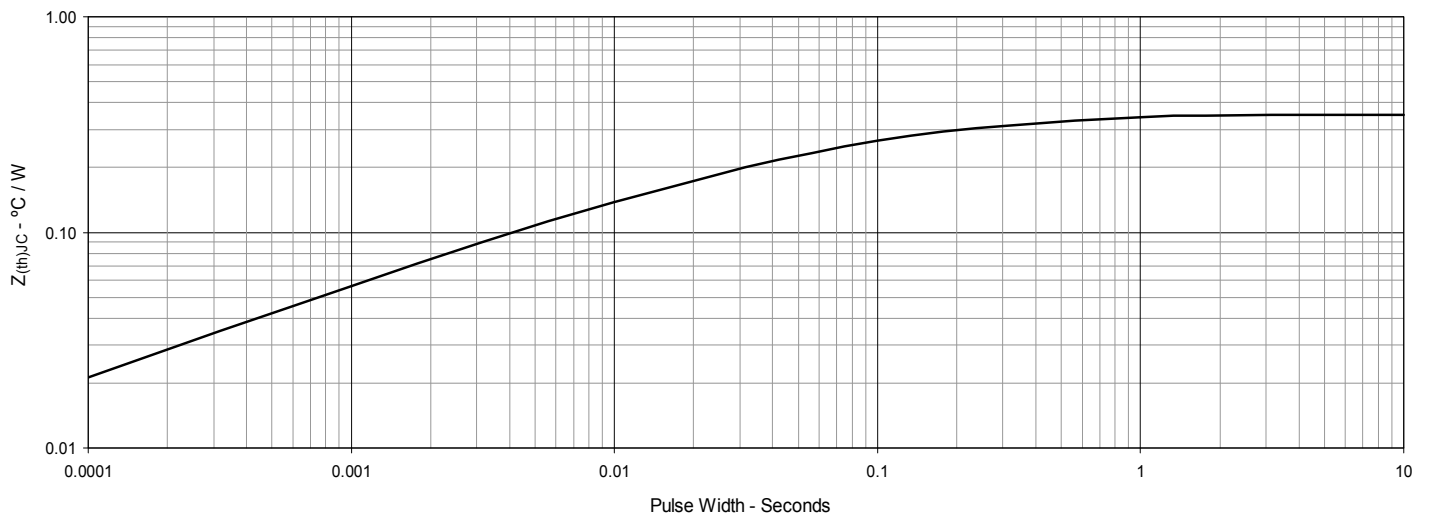
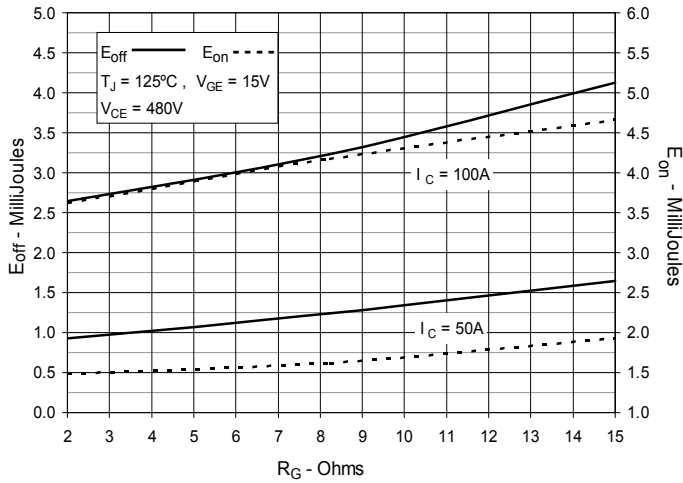


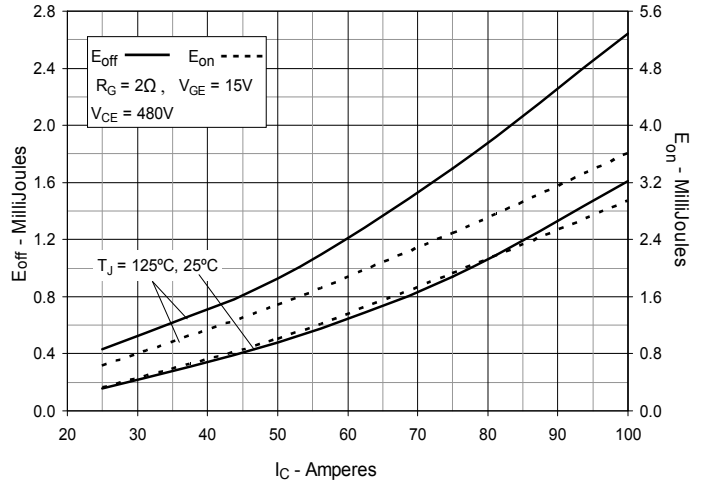
Fig. 11. Maximum Transient Thermal Impedance



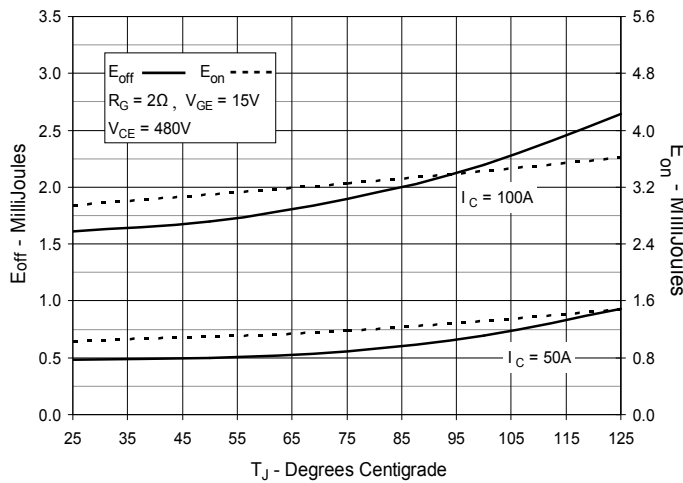
**Fig. 12. Inductive Switching
Energy Loss vs. Gate Resistance**



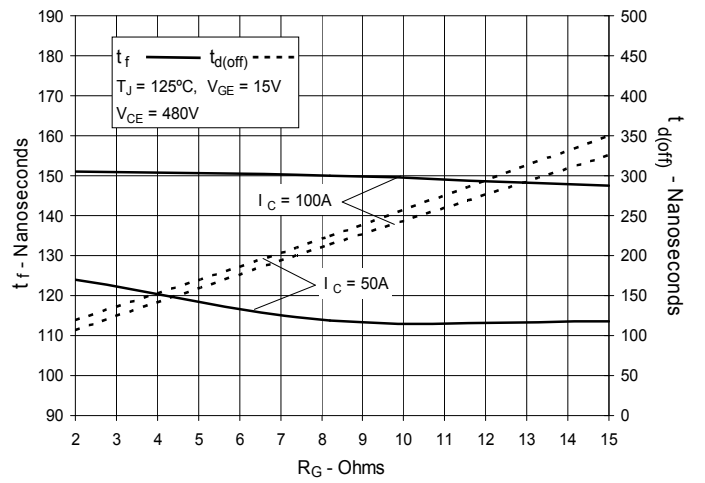
**Fig. 13. Inductive Switching
Energy Loss vs. Collector Current**



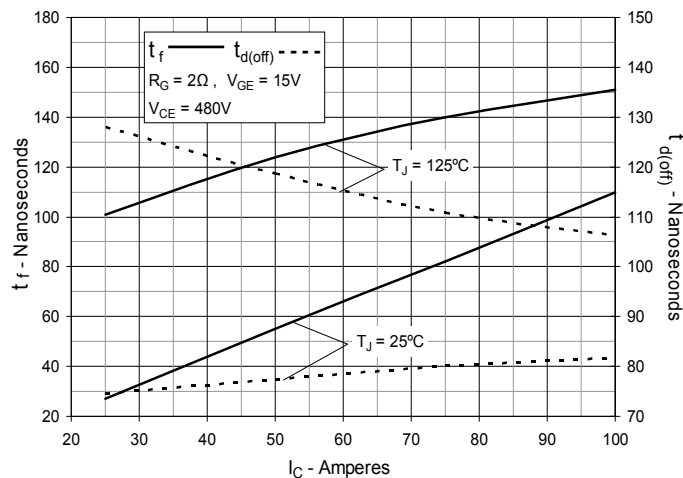
**Fig. 14. Inductive Switching
Energy Loss vs. Junction Temperature**



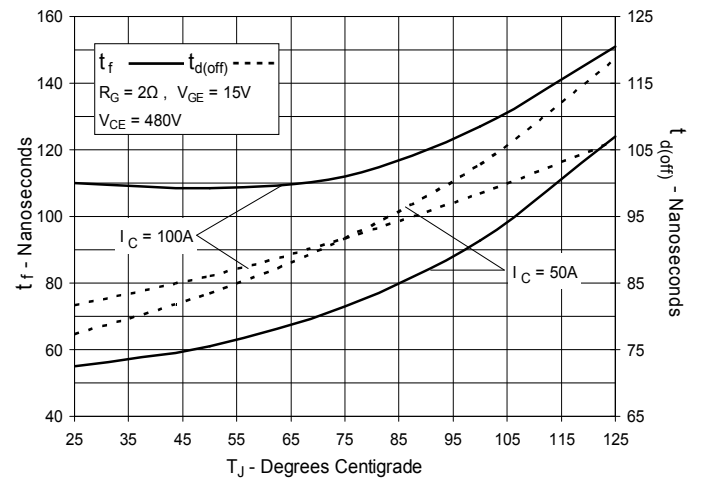
**Fig. 15. Inductive Turn-off
Switching Times vs. Gate Resistance**



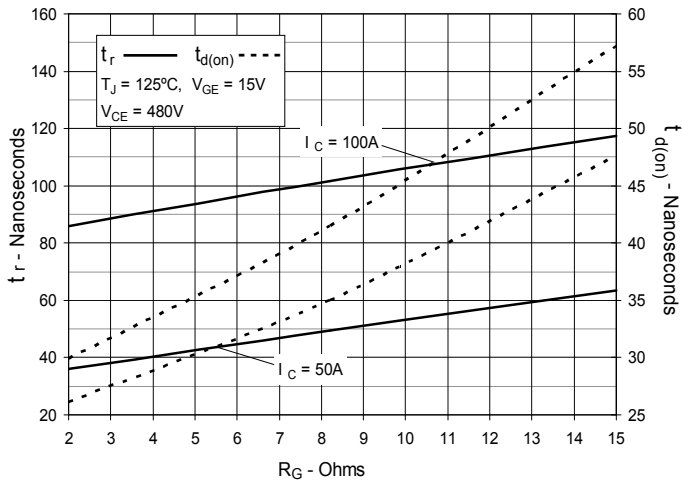
**Fig. 16. Inductive Turn-off
Switching Times vs. Collector Current**



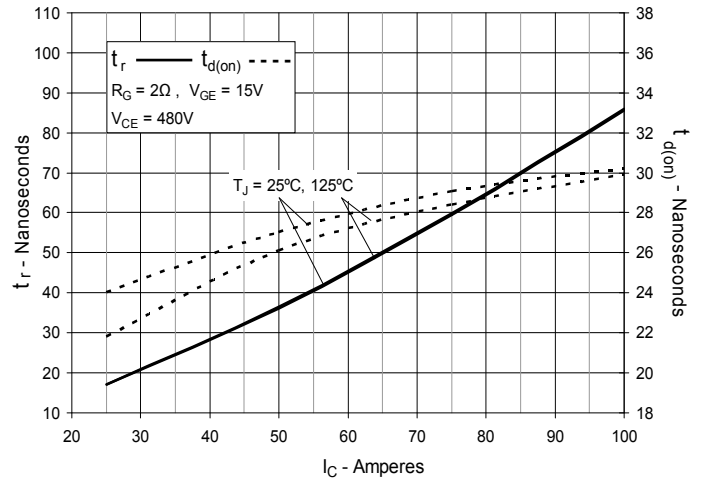
**Fig. 17. Inductive Turn-off
Switching Times vs. Junction Temperature**



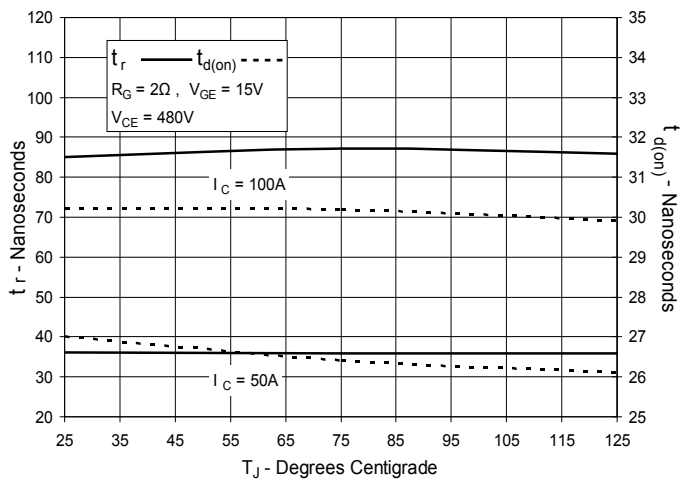
**Fig. 18. Inductive Turn-on
Switching Times vs. Gate Resistance**



**Fig. 19. Inductive Turn-on
Switching Times vs. Collector Current**



**Fig. 20. Inductive Turn-on
Switching Times vs. Junction Temperature**



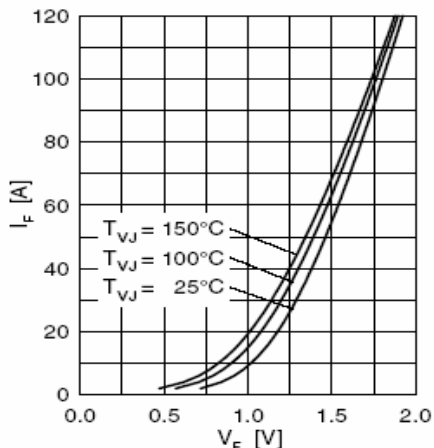


Fig. 21 Forward current I_F vs. V_F

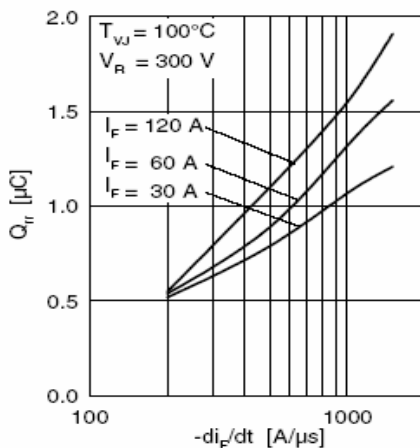


Fig. 22 Typ. reverse recovery charge Q_{rr}

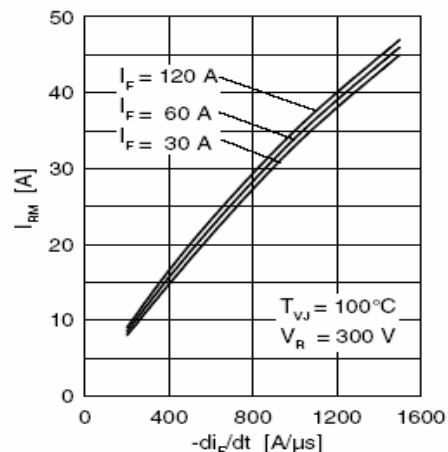


Fig. 23 Typ. peak reverse current I_{RM}

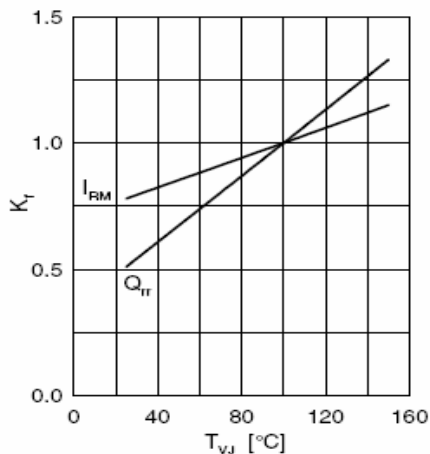


Fig. 24 Typ. dynamic parameters Q_{rr} , I_{RM}

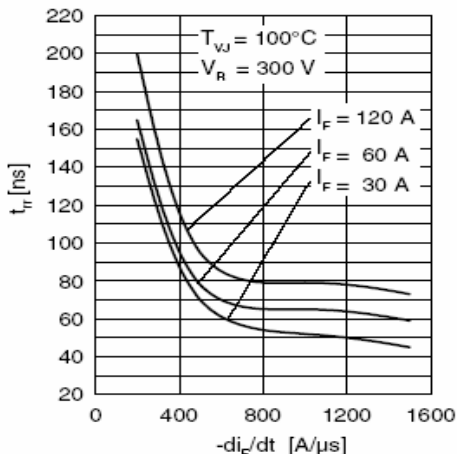


Fig. 25 Typ. recovery time t_{rr}

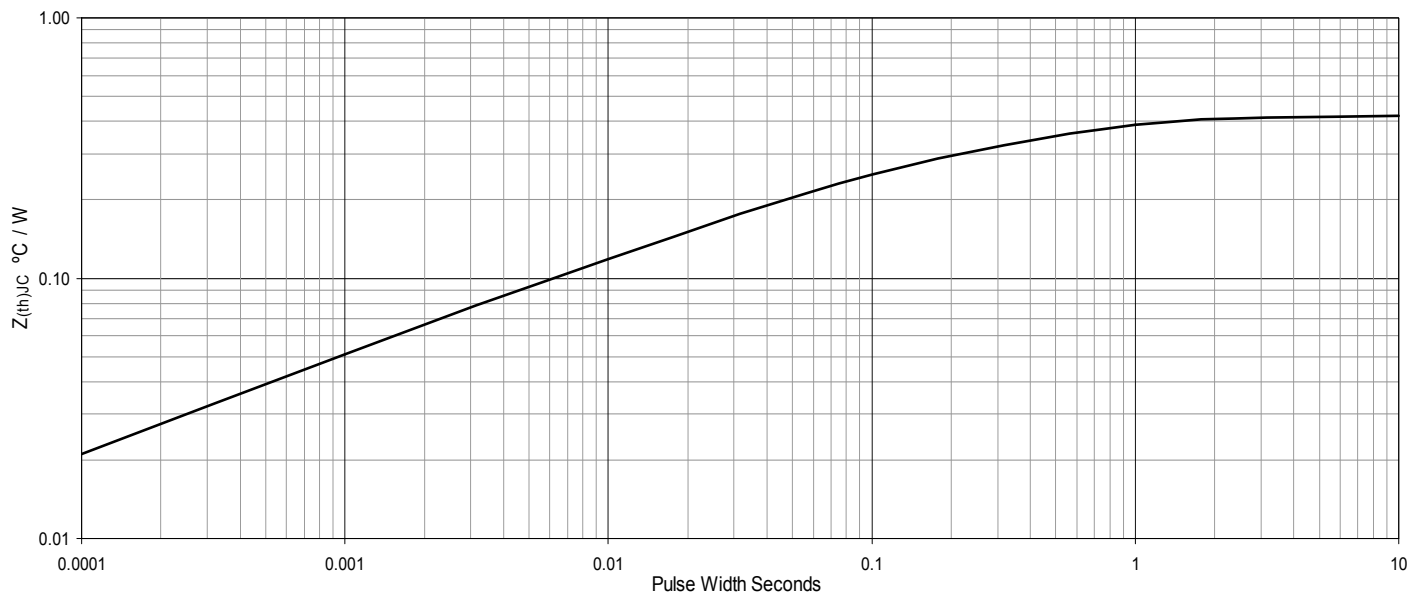


Fig. 26. Maximum Transient Thermal Impedance



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